

I, <u>Kiyoshi Tanaka</u>, residing at <u>c/o SAKAI International Patent Office</u>, <u>2-6</u>, <u>Kasumigaseki 3-chome</u>, <u>Chiyoda-ku</u>, <u>Tokyo 100-0013 Japan</u>, state:

that I know well both the Japanese and English languages;

that I translated, from Japanese into English, the specification, claims and abstract as filed in U.S. Patent Application No. <u>10/647,455</u>, filed <u>August 26, 2003</u>; and

that the attached English translation is a true and accurate translation to the best of my knowledge and belief.

Signature of Translator:

Kiyoshi Tanaka

Date: March 25, 2004